

1.6x0.8x0.5mm BI-COLOR SURFACE MOUNT **LED**

Part Number: APHB1608LCGKSURKC

Green Hyper Red

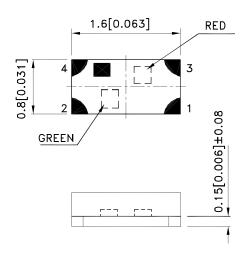
Features

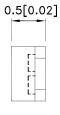
- 1.6mmX0.8mm SMD LED, 0.5mm thickness.
- Compatible with reflow soldering.
- Available in various color combination.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- Low current IF=2mA operating.
- RoHS compliant.

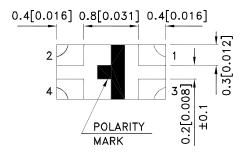
Descriptions

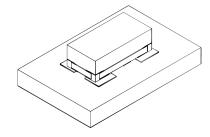
- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Emitting Color (Material)	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
			Min.	Тур.	201/2
APHB1608LCGKSURKC	Green (AlGaInP)	Water Clear	1.2	3	130°
			*1.2	*3	
	Hyper Red (AlGaInP)		10	20	
			*2	*8	

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous Flux: +/-15%.

 * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Min.	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	Green Hyper Red		574 645		nm	IF=2mA	
λD [1]	Dominant Wavelength	Green Hyper Red		570 630		nm	IF=2mA	
Δλ1/2	Spectral Line Half-width	Green Hyper Red		20 28		nm	IF=2mA	
С	Capacitance	Green Hyper Red		15 35		pF	VF=0V;f=1MHz	
VF [2]	Forward Voltage	Green Hyper Red	1.5 1.5	1.9 1.75	2.1 2.1	V	IF=2mA	
lR	Reverse Current	Green Hyper Red			10 10	uA	VR = 5V	

Notes:

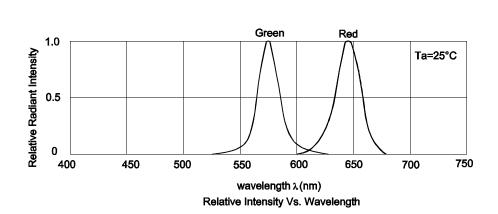
- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

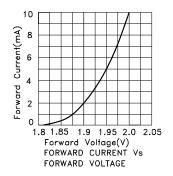
Parameter	Green	Hyper Red	Units			
Power dissipation	63	63	mW			
DC Forward Current	30	30	mA			
Peak Forward Current [1]	150	185	mA			
Reverse Voltage		V				
Operating Temperature	-40°C To +85°C					
Storage Temperature	-40°C To +85°C					

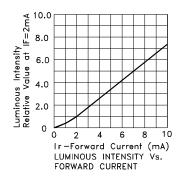
Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

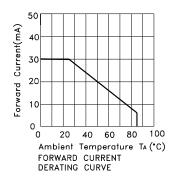
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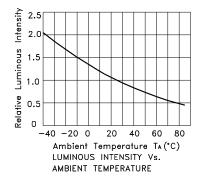


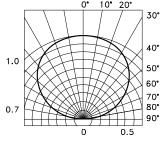
APHB1608LCGKSURKC Green









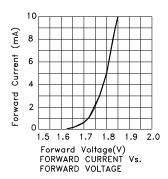


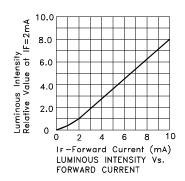
SPATIAL DISTRIBUTION

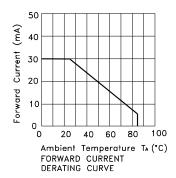
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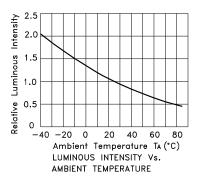
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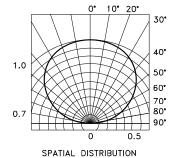
Hyper Red











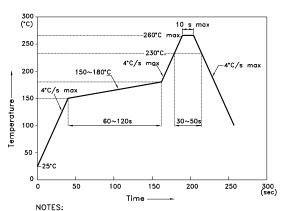
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



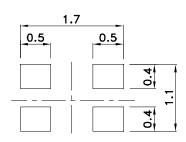
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

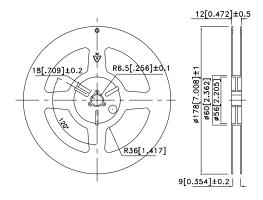
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

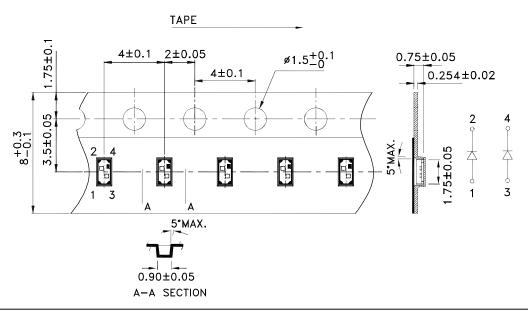
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)



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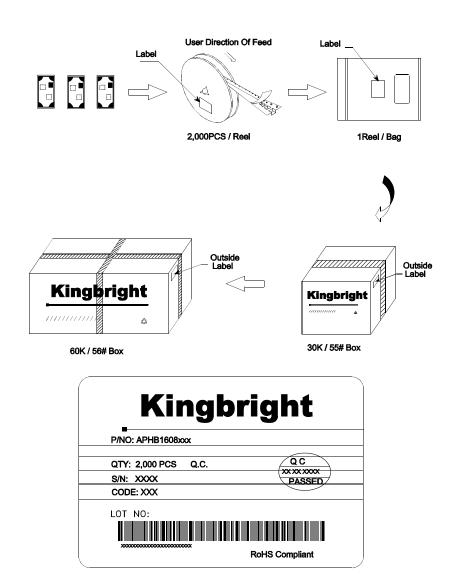
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PACKING & LABEL SPECIFICATIONS

APHB1608LCGKSURKC



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